

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc4225iufd-1#pbf

(Engineering Calculation)

QFN 4mm X 5mm Exp. Pad

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**TOTAL MASS (g) : 0.051924**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003468	1000000	66789.65625		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.019997	975000	385119.0625		
		Iron (Fe)	7439-89-6	0.000492	24000	9475.34960938		
		Phosphorus (P)	7723-14-0	0.000006	300	115.55304718		
		Zinc (Zn)	7440-66-6	0.000014	700	269.623779297		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.020509</b>	<b>1000000</b>	<b>394979.5625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000227	1000000	4375.76220703		
		<b>External Plating Total:</b>				<b>0.000227</b>	<b>1000000</b>	<b>4375.76220703</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000735	1000000	14155.2480469		
<b>Internal Plating Total:</b>				<b>0.000735</b>	<b>1000000</b>	<b>14155.2480469</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001346	750000	25922.3984375		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000449	250000	8647.21972656		
<b>Die Attach Total:</b>				<b>0.001795</b>	<b>1000000</b>	<b>34569.6210938</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.003244	130000	62475.6757812		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.021457	860000	413236.9375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000250	10000	4814.71044922		
		<b>Encapsulation Total:</b>				<b>0.024951</b>	<b>1000000</b>	<b>480527.3125</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000239	1000000	4602.86279297		
					<b>TOTAL MASS (g) :</b>	<b>0.051924</b>		